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PTO/SB/21 (08-03)
Approved for use through 08/30/2003. OMB 0651-0031
U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

•			Application Number	10/709	,710		
TRANSMITTAL FORM		Filing Date	05/24/	05/24/2004			
		First Named Inventor	Nien-H	Nien-Hui HSU			
(to be used for	all correspondence after initial	filing)	Art Unit				
			Examiner Name				
Total Number of Pages in This Submission 3			Attorney Docket Number	ОТМР	MP0079USA		
	•	ENC	LOSURES (Check all ti	hat apply)		
Fee Attached Amendment/Reply After Final Affidavits/declaration(s) Extension of Time Request Express Abandonment Request		Drawing(s) Licensing-related Papers Petition Petition to Convert to a Provisional Application Power of Attorney, Revocation Change of Correspondence Ad Terminal Disclaimer Request for Refund CD, Number of CD(s)	idress	A A OI	ppeal Cor f Appeals ppeal Cor Appeal Noti roprietary tatus Lette	osure(s) (please	
Incomplet	e to Missing Parts/ e Application esponse to Missing Parts ider 37 CFR 1.52 or 1.53	TURE (OF APPLICANT, ATTOR	NEY, C	OR AGEN	JT.	
m	Winston Hsu, Reg.			<u> </u>			
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Signature

PTO/SB/17 (10-03)

Approved for use through 07/31/2006. OMB 0651-0032 U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

FEE TRANSMITTAL for FY 2004

Effective 10/01/2003. Patent fees are subject to annual revision.

Applicant claims small entity status. See 37 CFR 1.27

TOTAL AMOUNT OF PAYMENT

(\$) 0.00

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Co	omplete if Known
Application Number	10/709,710
Filing Date	05/24/2004
First Named Inventor	Nien-Hui HSU
Examiner Name	
Art Unit	
Attorney Docket No.	OTMP0079USA

Date

METHOD OF PAYMENT (check all that apply)	FEE CALCULATION (continued)					
Check Credit card Money Other None	3. ADDITIONAL FEES					
Deposit Account:	Large I	Entity	Small	Entity		
Deposit Account 50-3105	Fee Code	,	Code	Fee (\$)	Fee Description	Fee Paid
Number	1051	130	2051		Surcharge - late filing fee or oath	
Deposit Account North America Intellectual Property Corp.	1052	50	2052	25	Surcharge - late provisional filing fee or cover sheet	
Name The Director is authorized to: (check all that apply)	1053	130	1053	130	Non-English specification	
Charge fee(s) indicated below Credit any overpayments	1812	2,520	1812	2,520	For filing a request for ex parte reexamination	<u> </u>
Charge any additional fee(s) or any underpayment of fee(s)	1804	920*	1804	920*	Requesting publication of SIR prior to Examiner action	
Charge fee(s) indicated below, except for the filing fee to the above-identified deposit account.	1805	1,840*	1805	1,840*	Requesting publication of SIR after Examiner action	
FEE CALCULATION	1251	110	2251	55	Extension for reply within first month	\vdash
1. BASIC FILING FEE	1252	420	2252	210	Extension for reply within second month	\vdash
Large Entity Small Entity	1253	950	2253	475	Extension for reply within third month	
Fee Fee Fee Fee Gee Paid Code (\$) Code (\$)	1254	1,480	2254	740	Extension for reply within fourth month	
Code (\$) Code (\$) 1001 770 2001 385 Utility filing fee	1255	2,010	2255	1,005	Extension for reply within fifth month	
1002 340 2002 170 Design filing fee	1401	330	2401	165	Notice of Appeal	
1003 530 2003 265 Plant filing fee	1402	330	2402	165	Filing a brief in support of an appeal	
1004 770 2004 385 Reissue filing fee	1403	290	2403	145	Request for oral hearing	
1005 160 2005 80 Provisional filing fee	1451	1,510	1451	1,510	Petition to institute a public use proceeding	
SUBTOTAL (1) (\$) 0.00	1452	110	2452	55	Petition to revive - unavoidable	
	1453	1,330	2453	665	Petition to revive - unintentional	
2. EXTRA CLAIM FEES FOR UTILITY AND REISSUE	1501	1,330	2501	665	Utility issue fee (or reissue)	
Extra Claims below Fee Paid	1502	480	2502	240	Design issue fee	
Total Claims	1503	640	2503	320	Plant issue fee	
Claims - 3" = L X L = 1	1460	130	1460	130	Petitions to the Commissioner	
Multiple Dependent	1807	50	1807	7 50	Processing fee under 37 CFR 1.17(q)	
Large Entity Small Entity Fee Fee Fee Fee Fee Description	1806	180	1806	180	Submission of Information Disclosure Stmt	
Code (\$) Code (\$)	8021	40	8021	40	Recording each patent assignment per property (times number of properties)	
1202 18 2202 9 Claims in excess of 20 1201 86 2201 43 Independent claims in excess of 3	1809	770	2809	385	Filing a submission after final rejection	
1203 290 2203 145 Multiple dependent claim, if not paid	1810	770	2810	385	(37 CFR 1.129(a)) For each additional invention to be	
1204 86 2204 43 ** Reissue independent claims	1				examined (37 CFR 1.129(b))	
over original patent	1801	770	2801		Request for Continued Examination (RCE)	
1205 18 2205 9 ** Reissue claims in excess of 20 and over original patent	1802	900	1802	900	 Request for expedited examination of a design application 	
SUBTOTAL (2) (\$) 0.00	Other fee (specify)				لــــــــــــــــــــــــــــــــــــــ	
**or number previously paid, if greater; For Reissues, see above	*Redu	uced by	Basic I	Filing F	ee Paid SUBTOTAL (3) (\$) 0.00	
SUBMITTED BY (Complete (if applicable))						
Name (Print/Type) Winston Hsu Registration No. 41,526 Telephone 886289237350						

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Attorney/Agent)

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DECLARATION — Supplemental Priority Data Sheet

Additional foreign applications:						
Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Not Claimed	Certified Copy Attached? YES NO		
1 092211591	Taiwan R.O.C	06/24/2003				
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7						
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प्रथा प्रथा प्रथा



中華民國經濟部智慧財產局

INTELLECTUAL PROPERTY OFFICE MINISTRY OF ECONOMIC AFFAIRS REPUBLIC OF CHINA

、茲證明所附文件,係本局存檔中原申請案的副本、正確無訛, 其申請資料如下:

This is to certify that annexed is a true copy from the records of this office of the application as originally filed which is identified hereunder:

申 請 日:西元<u>2003</u>年<u>06</u>月<u>24</u>日 Application Date

申 請 案 號: 092211591

Application No. -

申 請 人: 中強光電股份有限公司

Applicant(s)

局~

Director General



· 發文日期: 西元 <u>2004</u>年 <u>3</u> 月 <u>2</u>2/日

Issue Date

發文字號: 09320272040

Serial No.

26 전도 전도

申請日期:	IPC分類	
申請案號:		

上 明 采									
(以上各欄	由本局填	新型專利說明書							
	中文	進氣結構							
新型名稱	英文	INTAKE STRUCTURE							
		1. 許年輝 2. 吳上炫 3. 蘇文賢							
=	(英文)	1. Nien-Hui Hsu 2. Shang-Hsuang Wu 3. Wen-Hsien Su							
創作人 (共3人)	國籍、1. 中華民國 TW 2. 中華民國 TW 3. 中華民國 TW								
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i de	名稱或 姓 名 (中文)	1. 中強光電股份有限公司							
	名稱或 姓 名 (英文)	1. Coretronic Corporation							
= [國 籍 (中英文)	1. 中華民國							
申請人 (共1人)		1. 新竹科學工業園區新竹市力行路11號 (本地址與前向貴局申請者相同	引)						
	住居所 (營業所) (英 文)	1. No. 11. Li Hsin Rd. Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.							
ļ	代表人 (中文)	1. 張威儀							
	代表人 (英文)	1. Wade Chang							



四、中文創作摘要 (創作名稱:進氣結構)

英文創作摘要 (創作名稱: INTAKE STRUCTURE)

INTAKE STRUCTURE

An intake structure, installed in a projection apparatus having heating elements, includes an intake port on the casing, air duct and a blower near the heating elements. The inlet of the air duct is connected to the intake port, and the outlet is disposed at a side of the heating elements. The air stream from the intake port is directed through the air duct for concentrating the air stream to the heating elements inside of the projection apparatus. Thus, it can be





四、中文創作摘要 (創作名稱:進氣結構)

英文創作摘要 (創作名稱: INTAKE STRUCTURE)

provided the maximum cooling effect and enhanced cooling efficiency for heating elements.



四、中文創作摘要 (創作名稱:進氣結構)

伍、(一)、本案代表圖為:第____4___ 圖

(二)、本案代表圖之元件代表符號簡單說明:

投影裝置 20 發熱元件

光學引擎殼體 22 導風管 32

2 1

入口端 321 出口端 322

抽 風 扇 3 3

英文創作摘要 (創作名稱: INTAKE STRUCTURE)



一、本案已向			
國家(地區)申請專利	申請日期	案號	主張專利法第一百零五條準用 第二十四條第一項優先權
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二、□主張專利法第一百	筝五條準用第二十	-五條之一第一項	【傻无權:
申請案號:		無	
日期:			
	法第九十八條第一	-項□第一款但書	「或□第二款但書規定之期間
日期:			
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五、創作說明 (1)

【新型所屬之技術領域】

本創作係有關進氣結構,尤其係指一種應用於投影裝置之進氣結構。

【先前技術】

請參閱第1圖、第2圖及第3圖所示,習知投影裝置 10之進氣結構 11係於投影裝置 10下蓋 12開設複數個進氣孔 111,並於進氣孔 111附近設置一抽風扇 112,而將光學引擎殼體 14內之發熱元件 13(如:積分柱(integration rod)、中繼透鏡(relay)、聚光透鏡(condenser)等等)設於進氣孔 111附近,當啟動抽風扇 112將外界空氣流由進風孔 111 抽至投影裝置 10內,而空氣流流經發熱元件 13附近一

【新型內容】

本創作之一目的,係提供一種進氣結構,利用導風





五、創作說明 (2)

管設置來集中進風量,使空氣流可發揮最大效果冷卻發熱元件,避免增加風扇數量及轉速而降低發熱元件之溫度。

本創作之另一目的,係提供一種進氣結構,利用導風管引導空氣至發熱元件之附近,使冷卻空氣可直接流經發熱元件,以達到提高強制對流之散熱效率。

本創作之又一目的,係提供一種進氣結構,利用導風管之設置,縮小進氣面積,以有效阻絕漏光及噪音。

【實施方式】

有關本創作為達到上述目的,所採用之技術手段及其餘功效,茲舉二較佳實施例,並配合圖式加以說明如下:

請參閱第4圖及第5圖所示,本創作進氣結構30 係設於一投影裝置20內,且投影裝置20內設有發熱 元件21,如:積分柱(integration rod)、中繼透鏡 (relay)、聚光透鏡(condenser)、電子元件或色輪





五、創作說明 (3)

(color wheel)等等,發熱元件21裝設於光學引擎殼體22內。

該進氣結構30包括一進氣口31、一導風管 及一抽風扇3 3; 其中進氣口31設於投影裝置 導風管32為一直風道之中空管體 導 風 管 3 2 目可依發熱元件21數目或不同集中位置而設,且入口 1連接於進氣口3 1, 進氣口3 1面積依導風管 端 3 2 面積而設,使導引空氣流由進氣口 3 1 集 導風管 3 2 出口端 2 進入投影裝置20內, 位於發熱元件2 1,並儘量接近以提高直接冷卻效果, 本實施例中導風管32位於發熱元件21(如:積分柱 下側,並與發熱元件21有一距離(約1~10mm ;而抽風扇33位於發熱元件21附近,使導引外界 空氣流流至投影裝置20內且可流經發熱元件2

請參閱第6圖所示,當啟動抽風扇33使投影裝置20內氣壓低於外界大氣壓力而形成負壓,以迫使外界空氣流由進氣口31進入,後透過導風管32導引排至投影裝置20內,直接流經位於導風管32出口端322交發熱元件21,以改變熱邊界層(thermal

boundary layer)厚度並提高強制對流以增加熱傳效率,達到有效冷卻發熱元件21,最後,由抽風扇33帶走散熱空氣。

由於導風管32之設置,可集中由進氣口31進入之空氣,並完全導向位於導風管32出口處322之發





五、創作說明(4)

熱元件21,利用横切式冷卻(cross-flow cooling) 來提高散熱率,因此,可使外界空氣流充分發揮效能 來冷卻投影裝置20內之發熱元件21,與習知無導引 設計之進風結構相較之下,本創作之進風結構30不需 增加進氣口31面積來提高進風量或增加風扇數量、轉 速,即可有效將發熱元件21溫度降低20~30℃, 使發熱元件21維持在容許溫度下,以確保其功能運作 正常,可靠度及壽命不致因高溫而衰減。

另外,由於利用導風管32設計使進風集中,來提高冷卻發熱元件21之效果及進風量,使進氣口31面積可較習知進風結構縮減,故可減低漏光及噪音之顧慮

請參閱第7圖所示,導風管32A亦可為具有曲折 氣流通路徑之中空管體,以更有效阻絕漏光或噪音所 本實施例中係將導風管32A出口端322A垂直彎折 空氣流導向分布於不同位置之發熱元件21A、21B 、21C,分歧管323支射目、及分布位置係一發熱 元件21而設再由抽風扇33將散熱空氣抽離,以冷卻 發熱元件。

以上所述,僅用以方便說明本創作之較佳實施例, 本創作之範圍不限於該等較佳實施例,凡依本創作所做的任何變更,於不脫離本創作之精神下,皆屬本創作申 請專利範圍。





圖式簡單說明

【圖式簡要說明】

- 第1圖係習知投影裝置進風結構之立體圖。
- 第2圖係習知投影裝置進風結構之爆炸圖。
- 第3圖係習知投影裝置進風結構之空氣流動示意圖。
- 第4圖 係本創作進風結構之立體圖。
- 第5圖係本創作進風結構之爆炸圖。
- 第6圖係本創作進風結構之示意圖。
- 第7圖 係本創作另一進風結構之示意圖。

【圖號簡要說明】

- 投影裝置 20
- 發 熱 元 件 2 1 × 2 1 A × 2 1 B × 2 1 C
- 光學引擎殼體 22
- 進氣結構 30
- 進氣口 31
- 導風管 32、32A
- 入口端 321
- 出口端 322、322A
- 分歧管 323
- 抽風扇 33



六、申請專利範圍

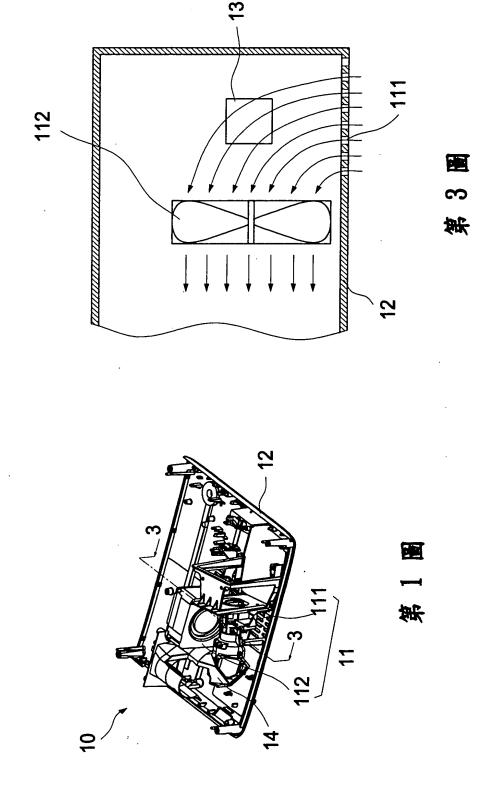
- 1、一種進氣結構,係設於設有至少一發熱元件之投影 裝置內,該進氣結構係包括:
 - 至少一進氣口,係設於該投影裝置上;
 - 至少一導風管,其入口端連接於該進氣口,出口端位於該發熱元件附近;以及
 - 一抽風扇,係位於該發熱元件附近,使外界空氣流經該發熱元件。
- 2、如申請專利範圍第1項所述之進氣結構,其中該導風管可具有曲折氣流流通路徑。
- 3、如申請專利範圍第2項所述之進氣結構,其中該導 風道之出口端可連接至少一分歧管。
- 4、如申請專利範圍第1項所述之進氣結構,其中該導風管可具有直風道。
- 5、如申請專利範圍第4項所述之進氣結構,其中該導 風道之出口端可連接至少一分歧管。
- 6、如申請專利範圍第1項所述之進氣結構,其中該導 風管出口端接近該發熱元件。
- 7、如申請專利範圍第1項所述之進氣結構,其中該抽風扇位於該發熱元件及導風管附近,以導引外界空氣流流經該發熱元件。
- 8、如申請專利範圍第1項所述之進氣結構,其中該導風管入口端面積係依進氣口面積而設。
- 9、如申請專利範圍第1項所述之進氣結構,其中該導風管數目係依該發熱元件數目而設。



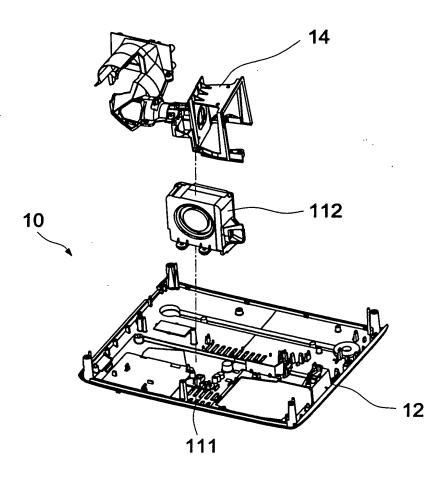
六、申請專利範圍

- 10、如申請專利範圍第1項所述之進氣結構,其中該發熱元件與導風管出口間之距離為1~10mm。
- 11、如申請專利範圍第1項所述之進氣結構,其中該發熱元件可為積分柱。
- 12、如申請專利範圍第1項所述之進氣結構,其中該發熱元件可為中繼透鏡。
- 13、如申請專利範圍第1項所述之進氣結構,其中該發熱元件可為聚光透鏡。
- 14、如申請專利範圍第1項所述之進氣結構,其中該發熱元件可為電子元件。
- 15、如申請專利範圍第1項所述之進氣結構,其中該發熱元件可為色輪。

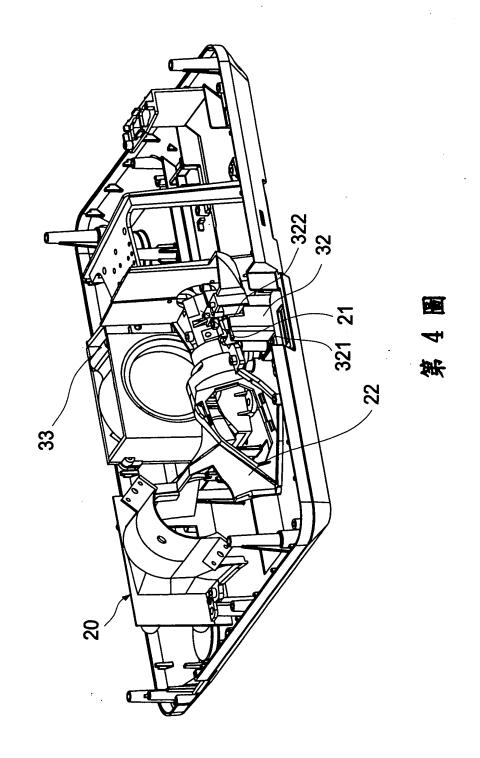




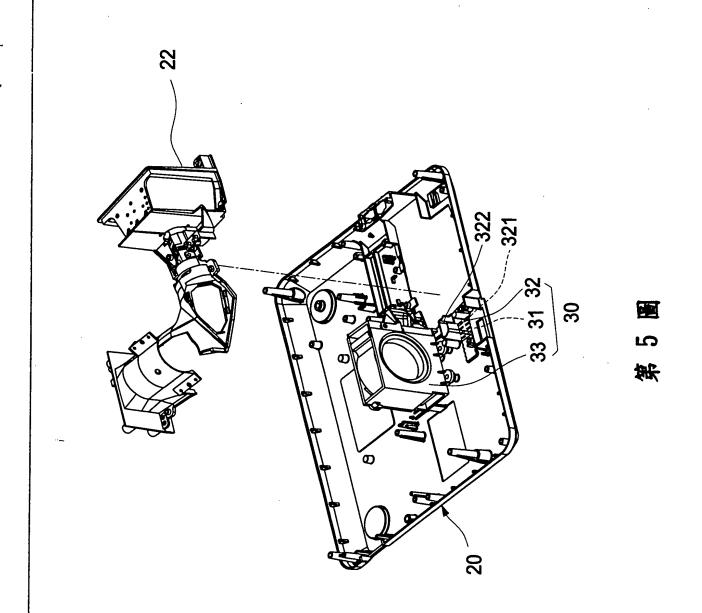
左圖

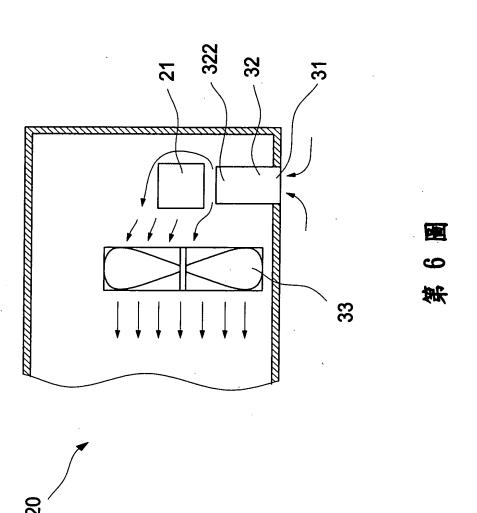


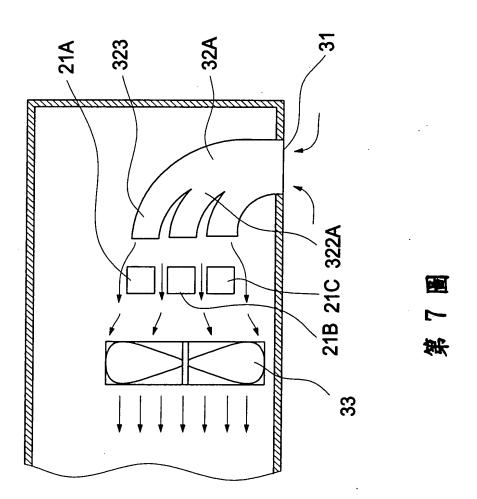
第 2 圖

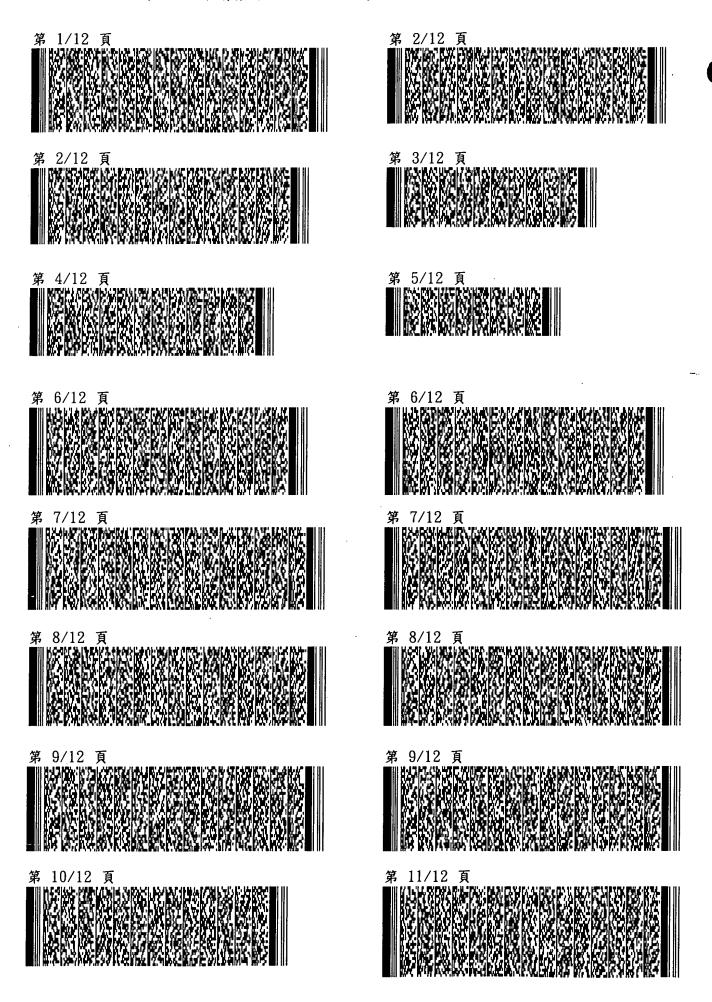


左圖









(4.5版)申請案件名稱:進氣結構

第 12/12 頁



